Electronic Patent Application Fee Transmittal							
Application Number:	10644640						
Filing Date:	20-Aug-2003						
Title of Invention:	POLYESTER MOLDING COMPOSITION						
First Named Inventor:	Sung Dug Kim						
Filer:	Marina T. Larson/Lori South						
Attorney Docket Number:	135680-1						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
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Utility Appl Issue fee		1501	1	1400	1400		

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